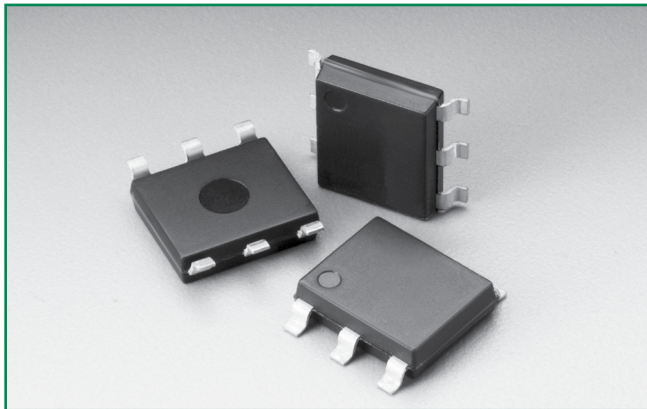


Asymmetrical Multiport Series - MS-013



Description


Asymmetrical Multiport Series are SIDACtor® components designed to protect LCAS (Line Circuit Access Switch) devices from damaging overvoltage transients.

The series provides a specialized asymmetrical dual port overvoltage protection solution that enables equipment to comply with various global regulatory standards.

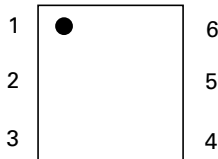
Features and Benefits

- Low voltage overshoot
- Low on-state voltage
- Does not degrade surge capability after multiple surge events within limit.
- Fails short circuit when surged in excess of ratings
- Replaces four discrete components
- Two-port protection
- RoHS Compliant, Lead-Free and Halogen Free
- LCAS specific tip and ring thresholds
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin (Sn) (IPC/JEDEC J-STD-609A.01)

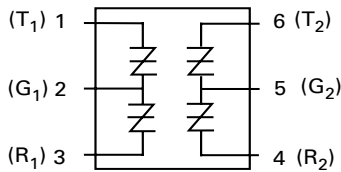
Agency Approvals

| Agency | Agency File Number |
|---|--------------------|
|  | E133083 |

Pinout Designation



Schematic Symbol



Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21 Enhanced Level*
- ITU K.20/21 Basic Level
- GR 1089 Inter-building*
- GR 1089 Intra-building
- IEC 61000-4-5 2nd edition
- YD/T 1082
- YD/T 993
- YD/T 950

*A-rated parts require series resistance

Additional Information



Datasheet



Resources



Samples

Electrical Characteristics

| Part Number | Part Marking | $V_{DRM} @ I_{DRM} = 5\mu A$ | $V_S @ 100V/\mu s$ | $V_{DRM} @ I_{DRM} = 5\mu A$ | $V_S @ 100V/\mu s$ | $V_T @ I_T = 2.2 \text{ Amps}$ | I_S mA | I_T A | I_H mA |
|-------------|--------------|------------------------------|--------------------|------------------------------|--------------------|--------------------------------|-------------|------------|-------------|
| | | V | V | V | V | V | | | |
| | | Pins 2-3, 5-6 | | Pins 1-2, 4-5 | | Pins 1-2, 2-3, 4-5, 5-6 | | | |
| A1220UA4Lxx | A1220UA4 | 100 | 130 | 180 | 220 | 4 | 800 | 2.2 | 120 |
| A1225UA4Lxx | A1250UA4 | 100 | 130 | 230 | 290 | 4 | 800 | 2.2 | 120 |
| A1220UC4Lxx | A1220UC4 | 100 | 130 | 180 | 220 | 4 | 800 | 2.2 | 120 |
| A1225UC4Lxx | A1250UC4 | 100 | 130 | 230 | 290 | 4 | 800 | 2.2 | 120 |

Notes:

- Absolute maximum ratings measured at $T_A = 25^\circ C$ (unless otherwise noted).
- Components are bi-directional.
- All electrical characteristics shown are defined from Tip to Ground (pin 1 to pin 2 and pin 6 to pin 5) and Ring to Ground (pin 3 to pin 2 and pin 4 to pin 5).
- XX = Part Number Suffix: 'TP' (Tube Pack) or 'RP' (Reel Pack).

Capacitance Values

| Part Number | pF Pin 1-2 / 4-5 Ring-Ground | | pF Pin 3-2 / 6-5 Tip-Ground | | pF Pin 1-3 (4-6) Tip-Ring | |
|-------------|------------------------------------|-----|-----------------------------------|-----|---------------------------------|-----|
| | MIN | MAX | MIN | MAX | MIN | MAX |
| A1220UA4Lxx | 15 | 25 | 30 | 50 | 5 | 20 |
| A1225UA4Lxx | 15 | 25 | 30 | 50 | 5 | 20 |
| A1220UC4Lxx | 35 | 50 | 60 | 90 | 20 | 35 |
| A1225UC4Lxx | 35 | 50 | 60 | 90 | 20 | 35 |

Note: Off-state capacitance (C_o) is measured at 1 MHz with a 2 V bias.

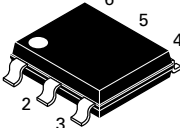
Surge Ratings

| Series | I _{PP} | | | | | | | | | | I _{TSM} 50/60 Hz | di/dt |
|--------|--|--|--|--|--|--|--|--|---|-------|------------------------------|-------|
| | 0.2/310 ¹ 0.5/700 ² | 2/10 ¹ 2/10 ² | 8/20 ¹ 1.2/50 ² | 10/160 ¹ 10/160 ² | 10/560 ¹ 10/560 ² | 5/320 ¹ 9/720 ² | 10/360 ¹ 10/360 ² | 10/1000 ¹ 10/1000 ² | 5/310 ¹ 10/700 ² | | | |
| | A min | A min | A min | A min | A min | A min | A min | A min | A min | A min | | |
| A | 20 | 150 | 150 | 90 | 50 | 75 | 75 | 45 | 75 | 20 | 500 | |
| C | 50 | 500 | 400 | 200 | 150 | 200 | 175 | 100 | 200 | 30 | 500 | |

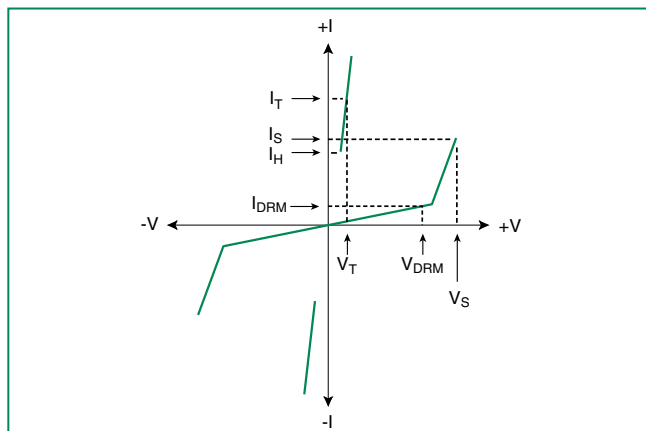
Notes:

- 1 Current waveform in μ s
- 2 Voltage waveform in μ s
- Peak pulse current rating (I_{pp}) is repetitive and guaranteed for the life of the product.
- I_{pp} ratings applicable over temperature range of -40°C to +85°C
- The component must initially be in thermal equilibrium with -40°C ≤ T_J ≤ +150°C

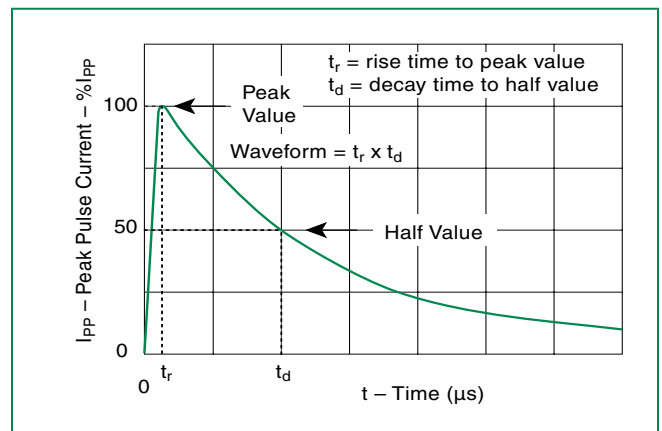
Thermal Considerations

| Package | Symbol | Parameter | Value | Unit |
|--|------------------|---|-------------|------|
| Modified MS-013  | T _J | Operating Junction Temperature Range | -40 to +125 | °C |
| | T _S | Storage Temperature Range | -65 to +150 | °C |
| | R _{θJA} | Thermal Resistance: Junction to Ambient | 60 | °C/W |

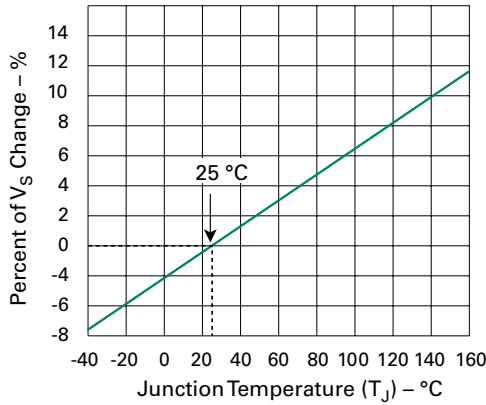
V-I Characteristics



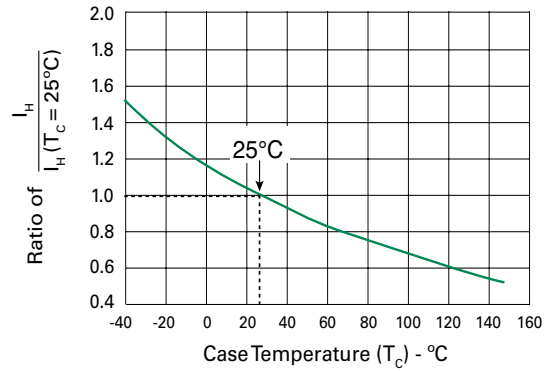
t_r x t_d Pulse Waveform



Normalized V_s Change vs. Junction Temperature

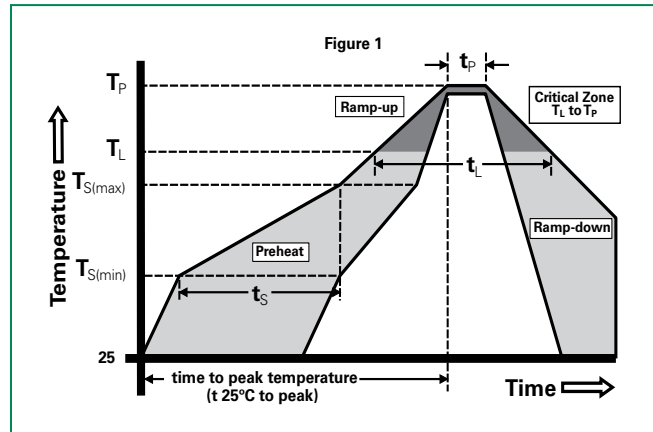


Normalized DC Holding Current vs. Case Temperature



Soldering Parameters

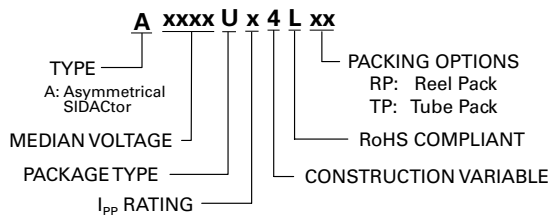
| | | |
|--|-----------------------------------|-------------------------------|
| Reflow Condition | | Pb-Free assembly (see Fig. 1) |
| Pre Heat | -Temperature Min ($T_{s(min)}$) | +150°C |
| | -Temperature Max ($T_{s(max)}$) | +200°C |
| | -Time (Min to Max) (t_s) | 60-180 secs. |
| Average ramp up rate (Liquidus Temp (T_L) to peak) | | 3°C/sec. Max. |
| $T_{s(max)}$ to T_L - Ramp-up Rate | | 3°C/sec. Max. |
| Reflow | -Temperature (T_L) (Liquidus) | +217°C |
| | -Temperature (t_L) | 60-150 secs. |
| Peak Temp (T_p) | | +260(+0/-5)°C |
| Time within 5°C of actual Peak Temp (t_p) | | 30 secs. Max. |
| Ramp-down Rate | | 6°C/sec. Max. |
| Time 25°C to Peak Temp (T_p) | | 8 min. Max. |
| Do not exceed | | +260°C |



Physical Specifications

| | |
|------------------------|---|
| Lead Material | Copper Alloy |
| Terminal Finish | 100% Matte-Tin Plated |
| Body Material | UL recognized epoxy meeting flammability classification V-0 |

Part Numbering



Environmental Specifications

| | |
|---|---|
| High Temp Voltage Blocking | 80% Rated V_{DRM} ($V_{AC, Peak}$) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101 |
| Temp Cycling | -65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A-104 |
| Biased Temp & Humidity | 52 V_{DC} (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101 |
| High Temp Storage | +150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101 |
| Low Temp Storage | -65°C, 1008 hrs. |
| Thermal Shock | 0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106 |
| Autoclave (Pressure Cooker Test) | +121°C, 100%RH, 2atm, 24 up to 168 hrs. EIA/JEDEC, JESD22-A-102 |
| Resistance to Solder Heat | +260°C, 30 secs. MIL-STD-750 (Method 2031) |
| Moisture Sensitivity Level | 85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1 |